

N-Channel 60-V (D-S) MOSFET

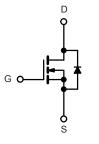
| PRODUCT SUMMARY | | |
|--|-----|-----|
| V _{DS} | 60 | V |
| R _{DS(on)} V _{GS} = 10 V | 11 | mΩ |
| $R_{DS(on)}$ $V_{GS} = 4.5$ V | 12 | mΩ |
| I _D | 75 | А |
| Configuration | Sin | gle |

FEATURES

- 175 °C Junction Temperature
- TrenchFET[®] Power MOSFET







N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T_C = | 25 °C, unless othe | rwise noted) | | | |
|---|---|-----------------------------------|--------------------------------------|----|--|
| Parameter | Symbol | Limit | Unit | | |
| Gate-Source Voltage | V _{GS} | ± 20 | V | | |
| Continuous Drain Current $(T = 475 °C)^{b}$ | T _C = 25 °C | 1 | 75 | | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 100 °C | D ID | 50 ^a | | |
| Pulsed Drain Current | I _{DM} | 200 | А | | |
| Continuous Source Current (Diode Conduction) | ۱ _S | 50 ^a | | | |
| Avalanche Current | I _{AS} | 50 | 1 | | |
| Single Avalanche Energy (Duty Cycle \leq 1 %) L = 0.1 mH | | E _{AS} | 125 | mJ | |
| Maximum Dowar Dissinction | $T_{\rm C} = 25 ^{\circ}{\rm C} \qquad $ | w | | | |
| Maximum Power Dissipation | T _A = 25 °C | FD FD | 3 ^b , 8.3 ^{b, c} | vv | |
| Operating Junction and Storage Temperature Range | · | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Marian a lunation to Archienta | t ≤ 10 sec | R _{thJA} | 15 | 18 | |
| Maximum Junction-to-Ambient ^a | Steady State | '`thJA | 40 | 50 | °C/W |
| Maximum Junction-to-Case | | R _{thJC} | 0.85 | 1.1 | |

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.

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|---|------|-------------|
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| Parameter | Symbol | Test Conditions | Min. | Typ. ^a | Max. | Unit | | |
|---|---------------------|---|------|-------------------|-------|------|--|--|
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V_{GS} = 0 V, I _D = 250 µA | 60 | | | V | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1 | | 3 | v | | |
| Gate-Body Leakage | I _{GSS} | V_{DS} = 0 V, V_{GS} = ± 20 V | | | ± 100 | nA | | |
| | | V_{DS} = 60 V, V_{GS} = 0 V | | | 1 | | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 125 °C | | | 50 | μA | | |
| | | V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 175 °C | | | 250 | | | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 10 V | 60 | | | Α | | |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.011 | | Ω | | |
| - · · · · · · · · · · · · · · · · · · · | | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.016 | | | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C | | 0.020 | | | | |
| | | V _{GS} = 4.5 V, I _D = 15 A | | 0.012 | | | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 20 A | | 60 | | S | | |
| Dynamic | | | | | | | | |
| Input Capacitance | C _{iss} | | | 4300 | | | | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 470 | | pF | | |
| Reverse Transfer Capacitance | C _{rss} | | | 225 | | | | |
| Total Gate Charge ^c | Qg | | | 47 | | | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{\rm DS}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 50 A | | 10 | | nC | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 12 | | 1 | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | | |
| Rise Time ^c | t _r | V_{DD} = 30 V, R _L = 0.6 Ω | | 15 | 25 | | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $\text{I}_\text{D}{\cong}50$ A, V_GEN = 10 V, Rg = 2.5 Ω | | 35 | 50 | ns | | |
| Fall Time ^c | t _f | | | 20 | 30 | | | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) | | · | | | | |
| Pulsed Current | I _{SM} | | | | 60 | А | | |
| Diode Forward Voltage | V _{SD} | I _F = 20 A, V _{GS} = 0 V | | 1 | 1.5 | V | | |
| Reverse Recovery Time | t _{rr} | I _F = 20 A, di/dt = 100 A/μs | | 45 | 100 | ns | | |

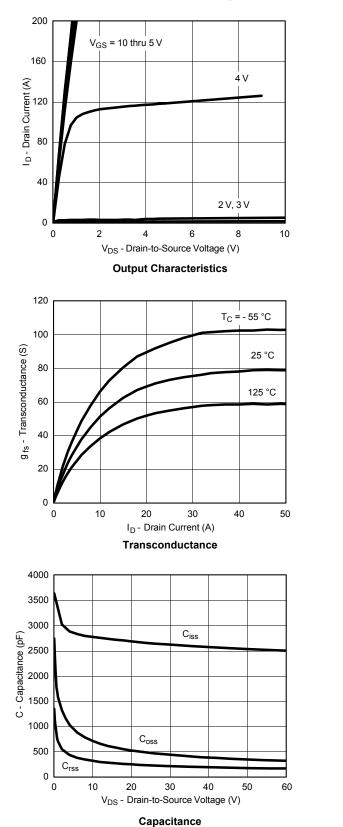
Notes:

a. For design aid only; not subject to production testing. b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

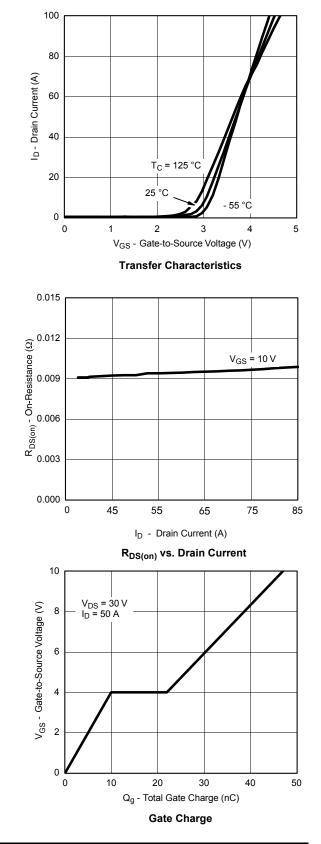
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



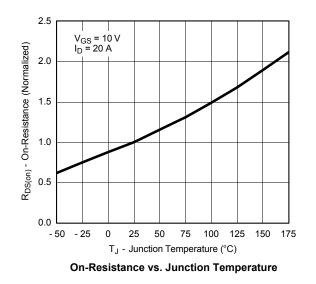


TYPICAL CHARACTERISTICS (25 °C unless noted)

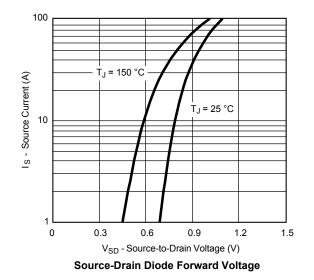


服务热线:400-655-8788

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TYPICAL CHARACTERISTICS (25 °C unless noted)



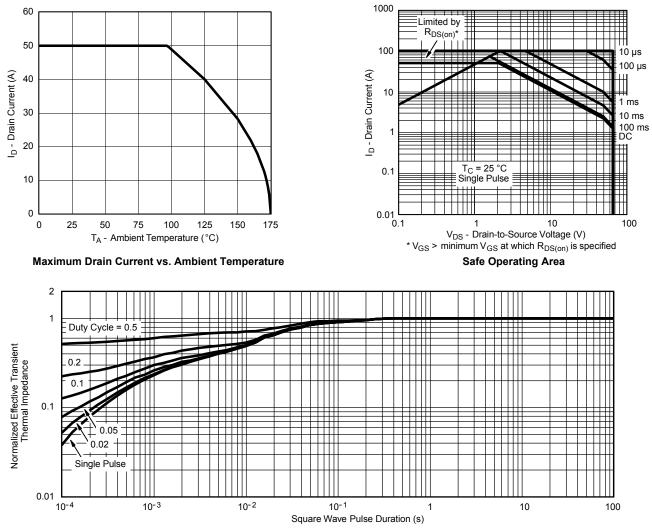
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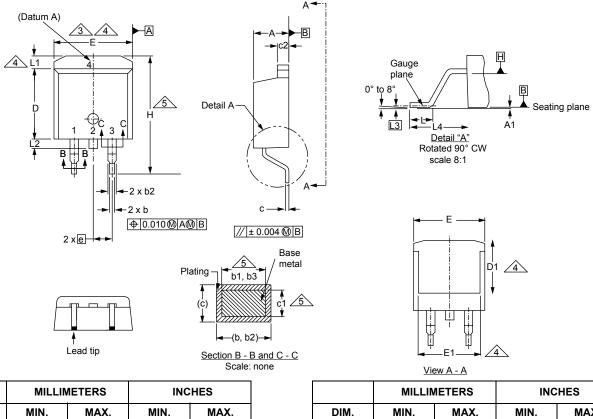
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-263AB (HIGH VOLTAGE)



| | WILLI | VIETERS | INC | HES | | | VIETERS | | HE9 |
|------|-------|---------|-------|-------|------|----------|---------|-------|-----|
| DIM. | MIN. | MAX. | MIN. | MAX. | DIM. | MIN. | MAX. | MIN. | м |
| А | 4.06 | 4.83 | 0.160 | 0.190 | D1 | 6.86 | - | 0.270 | |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | E | 9.65 | 10.67 | 0.380 | 0 |
| b | 0.51 | 0.99 | 0.020 | 0.039 | E1 | 6.22 | - | 0.245 | |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | е | 2.54 BSC | | 0.100 | BSC |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | Н | 14.61 | 15.88 | 0.575 | 0. |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | L | 1.78 | 2.79 | 0.070 | 0. |
| с | 0.38 | 0.74 | 0.015 | 0.029 | L1 | - | 1.65 | - | 0. |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | L2 | - | 1.78 | - | 0. |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | L3 | 0.25 BSC | | 0.010 | BSC |
| D | 8.38 | 9.65 | 0.330 | 0.380 | L4 | 4.78 | 5.28 | 0.188 | 0. |

Notes

- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

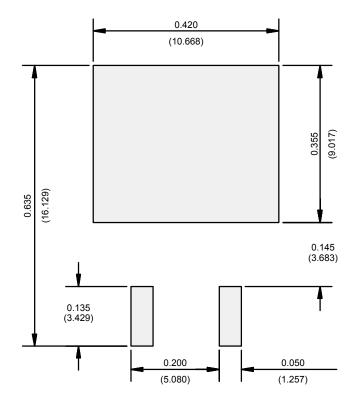
^{1.} Dimensioning and tolerancing per ASME Y14.5M-1994.

^{2.} Dimensions are shown in millimeters (inches).

^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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